IPC ASSOCIATION ELECTRONIC	© Copyright 200	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Form Type 'Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					us Material	ials and Mfg Information			
Supplie	r Information														
Company name* Company ur				unique ID t			Unique ID Authority					Response Date*			
nsemi												2024-04-20			
Contact N	lame		Title - Contact			1	Phone - Contact*]	Email - Contact*			
Product-l	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*		Title - Representative			1	Phone - Representative*				Email - Representative*				
Product-l	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Iter		n Number Mfr Item Name				Effective Date	Versio	n N	Manufacturing Site		W	eight*	UOM	Unit Type
		CAT24C08C4ATR 8KB I2C SER		8KB I2C SER EEI	PROM		2024-04-20 CI		CNQ		0.4	1682	mg	Each	
Ianufa	ecturing Process Infor	mation										·		·	
			-		-STD-020 MSL	Rating	Peak Proc	Process Body Temperature Max Time at Peak		e at Peak T	emperatur	e Numbe	er of Reflow Cyc	eles	
SnAgCu		CU Alloy 1				260 C 30				seconds 3					
omments															
<u>vel 1 - m</u>	naximum time at peak tempe	rature during so	ldering is 10	30 seconds											
or more	information regarding mate	rial composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.3895	mg	Supplier	Silicon (Si)	7440-21-3		0.3895	mg
Protection coat	0.0105	mg		Polyimide	proprietary data		0.0105	mg
RDL Sputter	4.0E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0003	mg
Solder Ball	0.0523	mg	Supplier	Silver (Ag)	7440-22-4		0.0014	mg
			Supplier	Tin (Sn)	7440-31-5		0.0506	mg
			Supplier	Copper (Cu)	7440-50-8		0.0003	mg
UBM/RDL PCu	0.0153	mg	Supplier	Copper (Cu)	7440-50-8		0.0153	mg
UBM Sputter	2.0E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0002	mg